

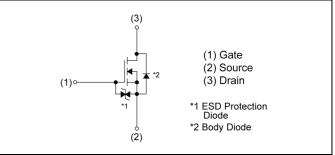
## Nch 4.5V 2.5A Middle Power MOSFET

## Datasheet

V <sub>DSS</sub>	45V
R <sub>DS(on)</sub> (Max.)	130mΩ
I <sub>D</sub>	±2.5A
P <sub>D</sub>	1.0W

# • Outline SOT-346T SC-96 TSMT3 (1) (3) (1) (2)

#### Inner circuit



## Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	180
Туре	Tape width (mm)	8
	Basic ordering unit (pcs)	3000
	Taping code	TL
	Marking	PW

#### • Absolute maximum ratings (T<sub>a</sub> = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V <sub>DSS</sub>	45	V
Continuous drain current	Ι <sub>D</sub>	±2.5	А
Pulsed drain current	I <sub>DP</sub> *1	±10	A
Gate - Source voltage	V <sub>GSS</sub>	±12	V
Dower dissinction	P <sub>D</sub> *2	1.0	W
Power dissipation	P <sub>D</sub> *3	0.76	W
Junction temperature	T <sub>j</sub>	150	°C
Operating junction and storage temperature range	T <sub>stg</sub>	-55 to +150	S°

•Features
1) Low on-resistance

2) Built-in G-S protection diode

Application

Switching

3) Small surface mount package(TSMT3)

## •Thermal resistance

Deremeter	Sumbol	Values			Unit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal registeres, junction, embient	$R_{thJA}^{*2}$	-	-	125	°C/W
Thermal resistance, junction - ambient	$R_{thJA}^{*3}$	-	-	165	°C/W

## •Electrical characteristics (T<sub>a</sub> = 25°C)

Deverseter	Symbol Conditions			Values			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	down $V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		45	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	I <sub>D</sub> = 1mA referenced to 25°C	-	46.8	-	mV/°C	
Zero gate voltage drain current			-	-	1	μA	
Gate - Source leakage current		$V_{GS}$ = ±12V, $V_{DS}$ = 0V	-	-	±10	μA	
Gate threshold voltage	$V_{GS(th)}$	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA	0.5	-	1.5	V	
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	I <sub>D</sub> = 1mA referenced to 25°C	-	-3.9	-	mV/°C	
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 2.5A	-	95	130		
Static drain - source on - state resistance	R <sub>DS(on)</sub> *4	V <sub>GS</sub> = 4V, I <sub>D</sub> = 2.5A	-	100	140	mΩ	
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 2.5A	-	125	175		
Gate resistance	R <sub>G</sub>	f = 1MHz, open drain	-	9.2	-	Ω	
Forward Transfer $ Y_{fs} ^{*4}$ $V_{DS} = 10V, I_D =$ Admittance		V <sub>DS</sub> = 10V, I <sub>D</sub> = 2.5A	2.0	-	-	S	

\*1 Pw $\leq$ 10µs, Duty cycle $\leq$ 1%

- \*2 Mounted on a ceramic board (30x30x0.8mm)
- \*3 Mounted on a FR4 (25x25x0.8mm)
- \*4 Pulsed



# • Electrical characteristics ( $T_a = 25^{\circ}C$ )

Deremeter	Cumphol	Conditions		Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	250	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10V	-	60	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	30	-	
Turn - on delay time	t <sub>d(on)</sub> *4	$V_{DD} \simeq 25 V, V_{GS} = 4.5 V$	-	9	-	
Rise time	t <sub>r</sub> *4	I <sub>D</sub> = 1.2A	-	15	-	20
Turn - off delay time	t <sub>d(off)</sub> *4	$R_L \simeq 20.8\Omega$	-	20	-	ns
Fall time	$t_{f}^{*4}$	R <sub>G</sub> = 10Ω	-	14	-	

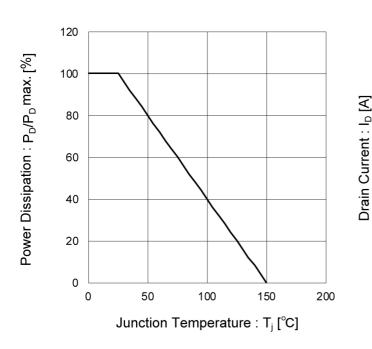
## • Gate charge characteristics ( $T_a = 25^{\circ}C$ )

Deremeter	Symbol	Conditions	Values			- Unit
Parameter	Symbol Conditions –		Min.	Тур.	Max.	Unit
Total gate charge	Q <sub>g</sub> *4	V <sub>DD</sub> ≃ 25V,	-	3.2	-	
Gate - Source charge	Q <sub>gs</sub> *4	I <sub>D</sub> = 2.5A,	-	0.9	-	nC
Gate - Drain charge	Q <sub>gd</sub> *4	V <sub>GS</sub> = 4.5V	-	0.7	-	

# •Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
Parameter Syr		Symbol Conditions		Тур.	Max.	Unit	
Continuous forward current	۱ <sub>s</sub>	T - 25°0	-	-	0.8	А	
Pulse forward current	$I_{SP}^{*1}$	T <sub>a</sub> = 25°C	-	-	10	А	
Forward voltage	$V_{SD}^{*4}$	V <sub>GS</sub> = 0V, I <sub>S</sub> = 2.5A	-	-	1.2	V	





## Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

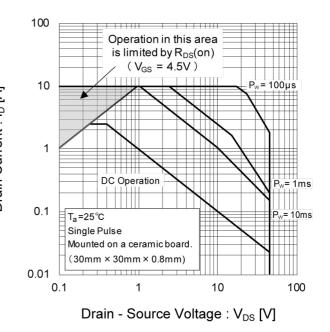
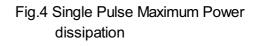
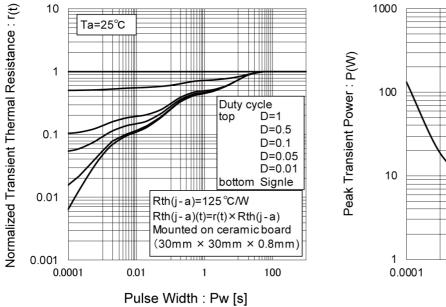
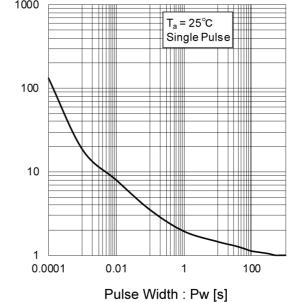


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width









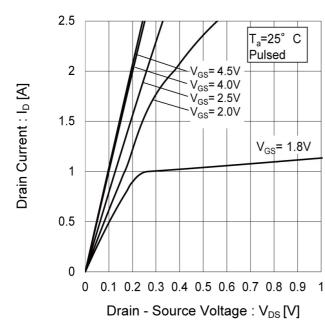


Fig.7 Breakdown Voltage vs.

Junction Temperature

### Fig.5 Typical Output Characteristics(I)

Fig.6 Typical Output Characteristics(II)

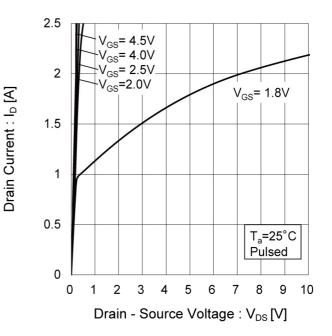
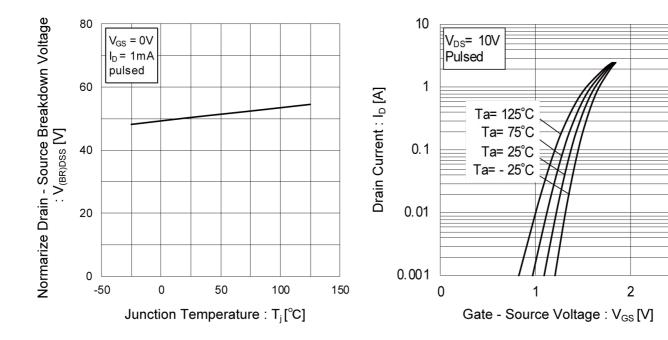


Fig.8 Typical Transfer Characteristics



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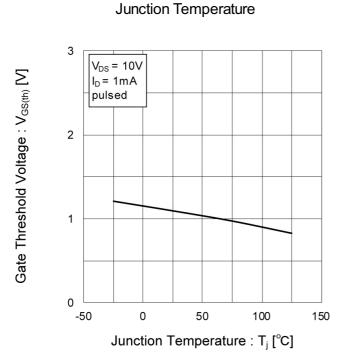


Fig.9 Gate Threshold Voltage vs.

## Fig.10 Forward Transfer Admittance vs. Drain Current

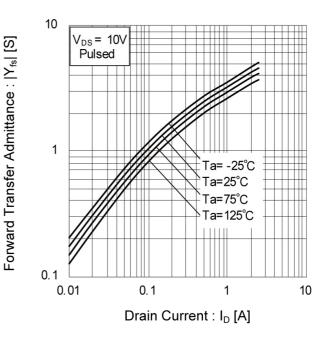
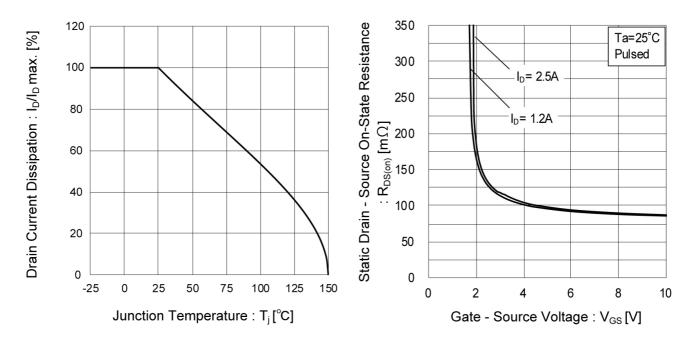


Fig.11 Drain Current Derating Curve

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage





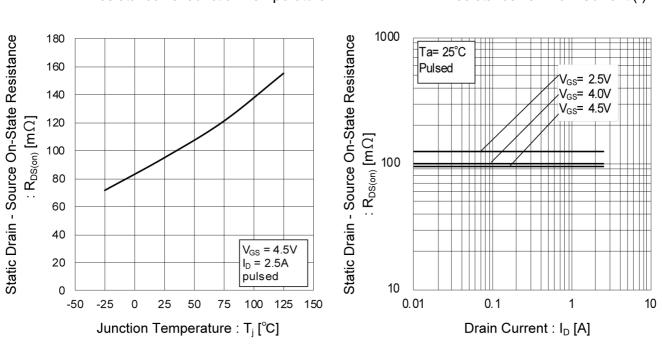
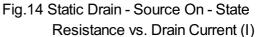


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature







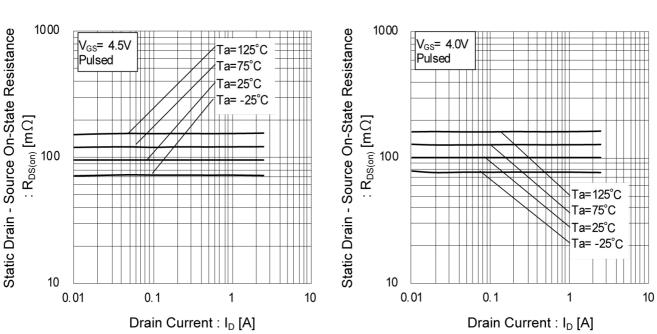
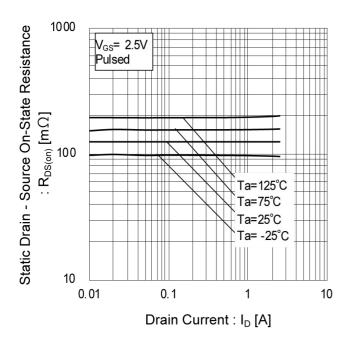


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II) Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

Fig.17 Static Drain - Source On - State Resistance vs. Drain Current (IV)







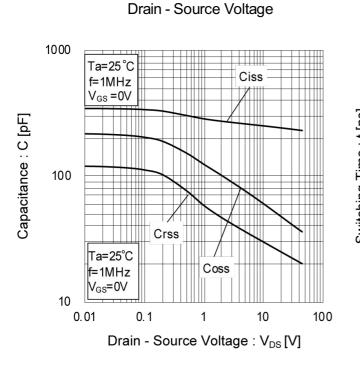


Fig.18 Typical Capacitance vs.

## Fig.19 Switching Characteristics

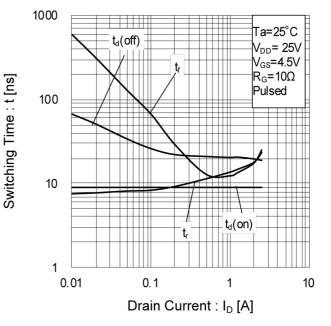
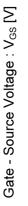


Fig.20 Dynamic Input Characteristics



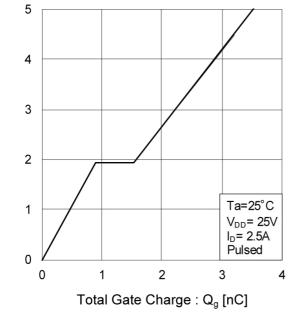
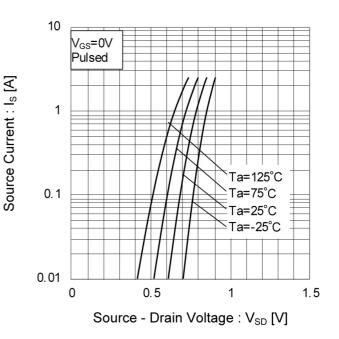


Fig.21 Source Current vs. Source Drain Voltage





#### Measurement circuits

#### Fig. 1-1 SWITCHING TIME MEASUREMENT CIRCUIT

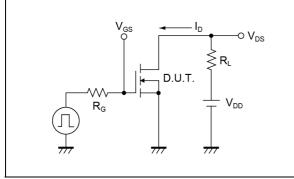
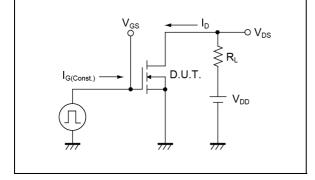


Fig. 2-1 GATE CHARGE MEASUREMENT CIRCUIT



#### Fig. 1-2 SWITCHING WAVEFORMS

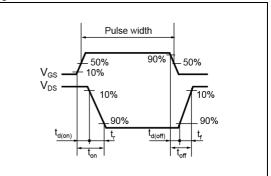
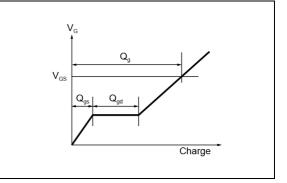


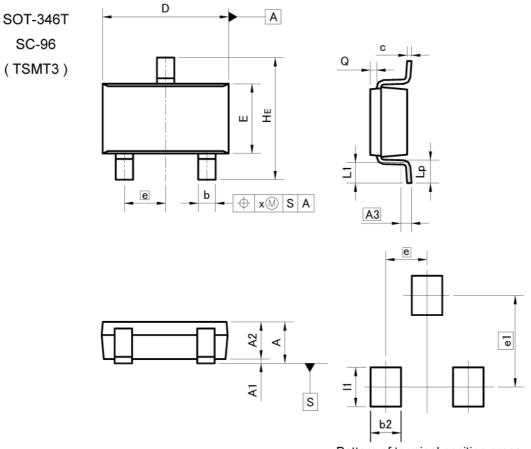
Fig. 2-2 GATE CHARGE WAVEFORM





#### RTR025N05

#### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	-	1.00	-	0.039
A1	0.00	0.10	0.000	0.004
A2	0.75	0.95	0.030	0.037
A3	0.:	25	0.0	10
b	0.35	0.50	0.014	0.020
с	0.10	0.26	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.	95	0.0	37
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.05	0.25	0.002	0.010
x	-	0.20	-	0.008

DIM	MILIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
b2		0.70	-	0.028	
e1	2.	10	0.0	83	
11	-	0.90	<del></del>	0.035	

Dimension in mm/inches



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CLASSⅣ	CLASSII	CLASSⅢ	CLASSII

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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